

MOSFET

OptiMOS[™] Power-Transistor, -100 V

Features

- P-channel
- Very low on-resistance R_{DS(on)} @ V_{GS}= 4.5 V
 Logic level
 100% avalanche tested

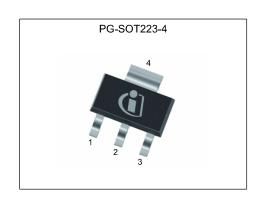
- Enhancement mode
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

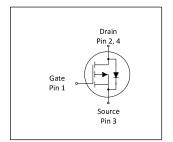
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Rey Lettormance Larameters							
Parameter	Value	Unit					
$V_{ extsf{DS}}$	-100	V					
$R_{ extsf{DS(on)}, ext{max}}$	980	m $Ω$					
I _D	-1.55	A					
Qoss	-2.3	nC					
Q_{G}	-3.6	nC					











Type / Ordering Code	Package	Marking	Related Links
ISP98DP10LM	PG-SOT223-4	98DP10LM	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Comple al	Values				N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	-1.55 -0.98 -0.95 -0.93	A	$V_{\rm GS}$ =-10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =-10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =-4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =-10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =70 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	-6.2	Α	T _A =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	45	mJ	$I_{\rm D}$ =-0.9 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	5.0 1.8	w	T _C =25 °C T _A =25 °C, R _{thJA} =70 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1 55/150/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Downwater	Cumbal		Values		I I m i 4	nit Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	25	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area	R _{thJA}	_	-	70	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

³⁾ See Diagram 3 for more detailed information⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Damana dam	0		Values		11!4	N 1 17 10 111
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	-100	-	-	V	V _{GS} =0 V, I _D =-1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	-1.0	-1.5	-2.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = -165 \ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	-0.1 -10	-1.0 -100	μΑ	V _{DS} =-100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =-100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	-10	-100	nA	V _{GS} =-20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	802.1 845.8	980 1050	mΩ	V _{GS} =-10 V, I _D =-0.9 A V _{GS} =-4.5 V, I _D =-0.7 A
Gate resistance	R _G	-	4.4	-	Ω	-
Transconductance	g_{fs}	-	2.5	-	S	V _{DS} ≥2 I _D R _{DS(on)max} , I _D =-0.9 A

 Table 5
 Dynamic characteristics

Parameter	Coursels all		Values	;	11:4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	C _{iss}	-	270	350	pF	V _{GS} =0 V, V _{DS} =-50 V, <i>f</i> =1 MHz	
Output capacitance ¹⁾	Coss	-	20	26	pF	V _{GS} =0 V, V _{DS} =-50 V, <i>f</i> =1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	6	10	pF	V _{GS} =0 V, V _{DS} =-50 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	9.98	_	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.9 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	6.24	-	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.9 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	14.01	_	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.9 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	8.18	_	ns	$V_{\rm DD}$ =-50 V, $V_{\rm GS}$ =-10 V, $I_{\rm D}$ =-0.9 A, $R_{\rm G,ext}$ =1.6 Ω	



Gate charge characteristics¹⁾ Table 6

Parameter	Comple at		Values	5	11:4	Nata / Tast Canalitian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	$Q_{ m gs}$	-	-0.8	-	nC	V_{DD} =-50 V, I_{D} =-0.9 A, V_{GS} =0 to -4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	-0.4	-	nC	V_{DD} =-50 V, I_{D} =-0.9 A, V_{GS} =0 to -4.5 V
Gate to drain charge ²⁾	Q_{gd}	-	-1.8	-2.7	nC	V_{DD} =-50 V, I_{D} =-0.9 A, V_{GS} =0 to -4.5 V
Switching charge	Q_{sw}	-	-2.1	-	nC	V _{DD} =-50 V, I _D =-0.9 A, V _{GS} =0 to -4.5 V
Gate charge total ²⁾	Q_{g}	-	-3.6	-4.5	nC	V _{DD} =-50 V, I _D =-0.9 A, V _{GS} =0 to -4.5 V
Gate plateau voltage	V _{plateau}	-	-2.8	-	V	V_{DD} =-50 V, I_{D} =-0.9 A, V_{GS} =0 to -4.5 V
Gate charge total	$Q_{\rm g}$	-	-7.2	-	nC	$V_{\rm DD}$ =-50 V, $I_{\rm D}$ =-0.9 A, $V_{\rm GS}$ =0 to -10 V
Output charge ²⁾	Qoss	-	-2.3	-3.1	nC	V _{DS} =-50 V, V _{GS} =0 V

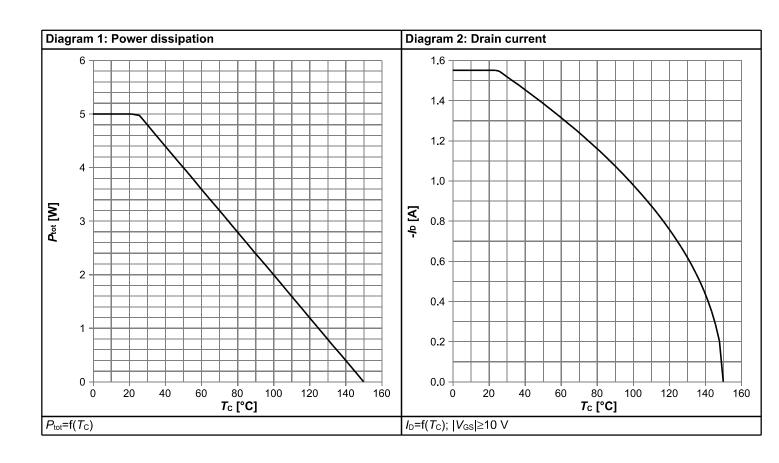
Table 7 Reverse diode

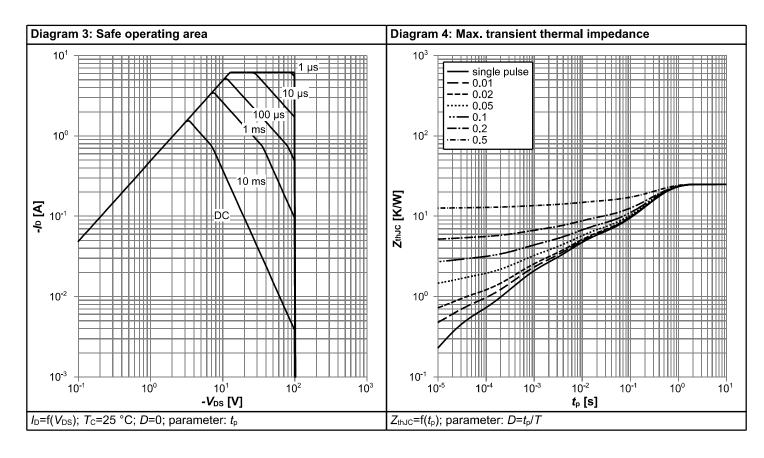
Parameter	Cymhol		Values	;	Unit	Note / Test Condition	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	-1.55	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	-6.2	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	-0.81	-1.2	V	V _{GS} =0 V, I _F =-0.9 A, T _j =25 °C	
Reverse recovery time ²⁾	<i>t</i> _{rr}	-	19.41	38.82	ns	V _R =-50 V, I _F =-0.9 A, d <i>i</i> _F /d <i>t</i> =-100 A/µs	
Reverse recovery charge ²⁾ Q _{rr}		-	21.71	43.42	nC	V _R =-50 V, I _F =-0.9 A, dI _F /dt=-100 A/µs	

 $^{^{1)}}$ See "Gate charge waveforms" for parameter definition $^{2)}$ Defined by design. Not subject to production test.

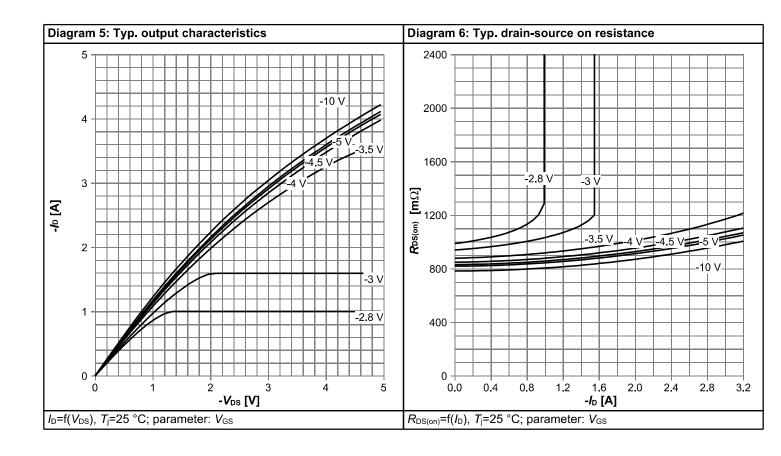


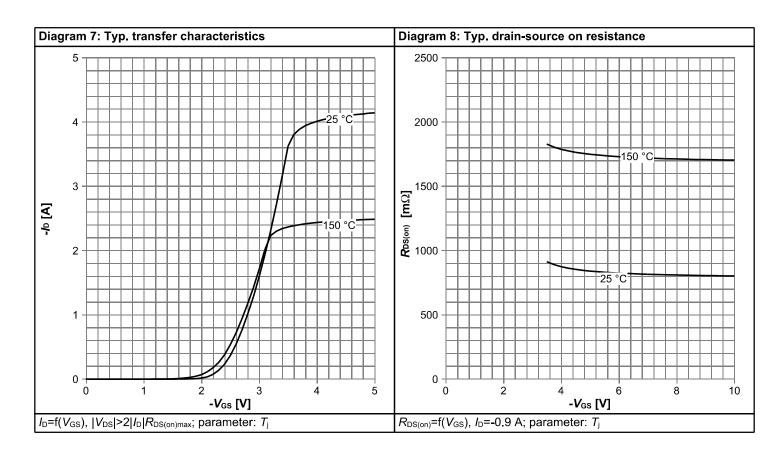
4 Electrical characteristics diagrams



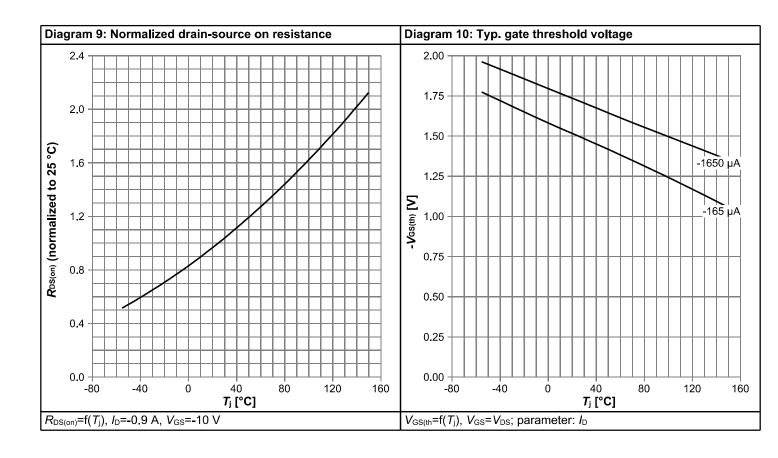


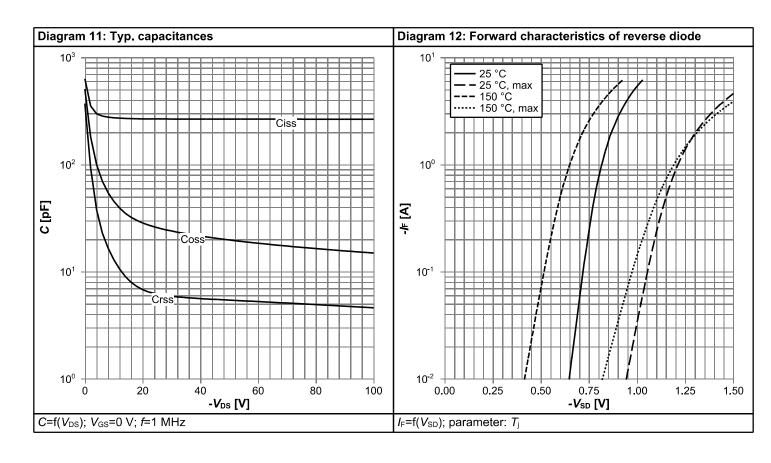




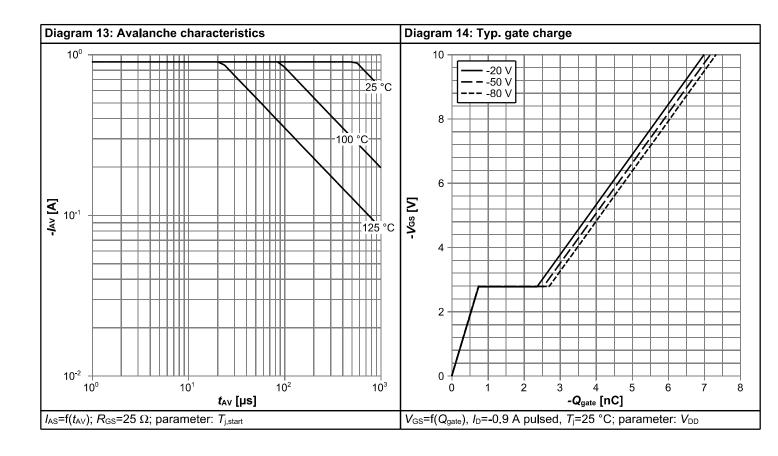


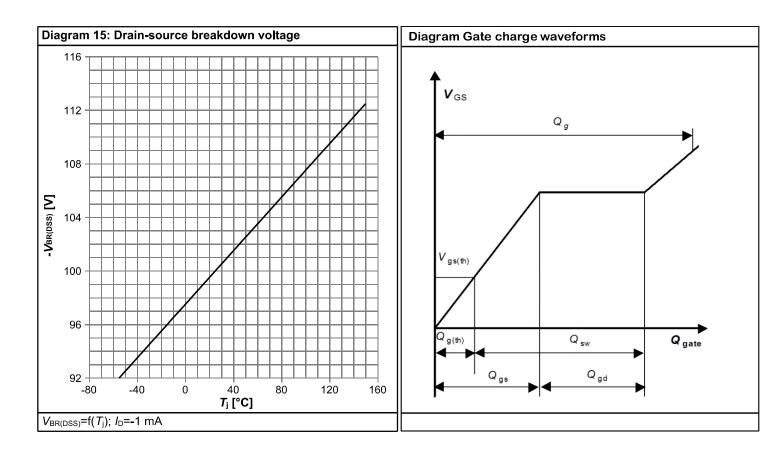






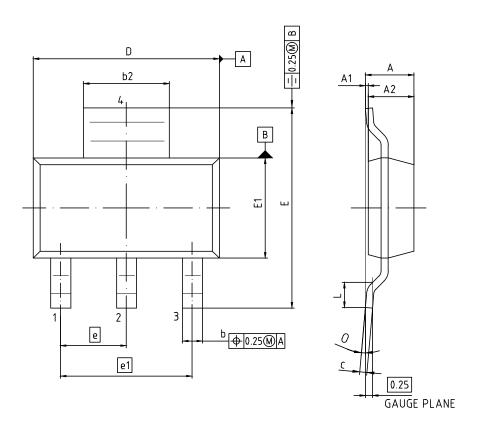








Package Outlines 5



DIMENSION	MILLIMETERS					
DIMENSION	MIN.	MAX.				
Α	1.60	1.80				
A1	-	0.10				
A2	1.50	1.70				
b	0.60	0.80				
b2	2.90	3.10				
С	0.24	0.32				
D	6.30	6.70				
E	6.70	7.30				
E1	3.30	3.70				
е	2.30					
e1	4.60					
L	0.75	-				
0	0°	10°				

Figure 1 Outline PG-SOT223-4, dimensions in mm

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0 1 2mm
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Revision History

ISP98DP10LM

Revision: 2021-05-10, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-05-10	Release of final version

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